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PATENT

IN THE BUTTED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Suan J. Boon

Examiner: James M. Mitchell

Serial No.:

10/722,838

Group Art Unit: 2813

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Title:

METHOD OF PACKAGING AT A WAFER LEVEL

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

This responds to the Office Action mailed on <u>September 20, 2006</u>. Please amend the above-identified patent application as follows.